



Welcome to our IPI Newsletter (Edition May 2009)

**IPI Seminar «Packaging Machines»**  
**IPI Seminar «Print Standards»**  
**IPI Study Tour USA**  
**Review Easy Fairs Award**  
**Preview IPI Events 2009**



### **Register now for IPI Seminar «Packaging Machines»**

This IPI seminar delivers a comprehensive technological background on packaging machines. Participants will learn about different packaging types and the related machines and gain a complete understanding of critical success factors of packaging systems. It is suitable for new employees in the packaging industry, specialists who want to broaden their knowledge and for employees with practical experience who are looking to upgrade and update their technological knowledge. Therefore this seminar is equally suitable for technical staff and engineers in production, R&D, supply chain management, product management and sales.

#### **Content:**

Market Overview Packaging Machines  
Packaging Machines  
Packaging Systems  
Packaging Machine Design & Construction  
Packaging Machine Performance and Reliability  
Intellectual Property, Regulatory Issues and Technical Standards

#### **Language:**

German

#### **Duration:**

2 \* 3 days

#### **Dates:**

3. - 5. June and 24. - 26. June 2009

**[For further details please click here](#)**



### **IPI Seminar «Print Standards in Packaging: Feasible and valuable?»**

Standards are successfully implemented in publication offset printing and companies working with these standards profit from high and consistent quality, low waste rates, savings in material and time, clear responsibilities and improved communication for all parties involved.

Could standards in packaging printing provide the same benefits?  
What kind of practices and tools are already available?

Ten top speakers highlight this topic in regard to the different print technologies and print process steps.

**Date:**  
June 10th

**Language:**  
German

**[For the detailed program click here](#)**



### **Study Tour «Packaging in the USA»**

The 6 day US Study Tour will deliver a comprehensive insight into the US Packaging market. The program includes lectures at Michigan State University and interesting plant visits.

**[For further information click here](#)**

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### **Review Easy Fairs Award**

In order to promote sustainable solutions in packaging, Easy Fairs organised the first Swiss Easy Fairs Packaging Award in cooperation with the IPI International Packaging Institute and the VLI, a Swiss packaging expert network.

The winner of the first Easy Fairs Packaging Award in Switzerland is PAGO. Prof. Dr. Ingo Büren from IPI as head juror pointed out in the ceremony that PAGO is a worthy recipient with its innovative and waste reducing liner-less labelling technology.

**[More information about this winning technology](#)**

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### **Preview IPI Events 2009**

**August 28th:** Packaging in India (VLI – IPI Event)

**November 26./27th:** Sustainability

**[Further details will be published on IPI homepage soon](#)**

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